

Product Summary

$V_{(BR)DSS}$	$R_{DS(on)MAX}$	I_D
60V	17mΩ@10V	45A
	23mΩ@4.5V	

Feature

- Fast switching speed
- Surface mount package

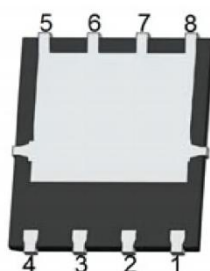
Application

- DC-DC converters
- Motor control

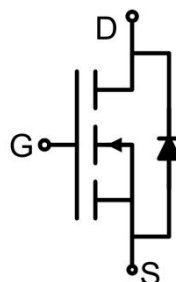
Package



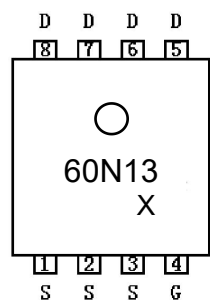
PDFN5*6-8L



Circuit diagram



Marking



Absolute maximum ratings ($T_A=25^{\circ}\text{C}$, unless otherwise noted)

Parameter	Symbol	Value	Unit
Drain-Source Voltage	V_{DS}	60	V
Gate-Source Voltage	V_{GS}	± 20	V
Continuous Drain Current ($T_C = 25^{\circ}\text{C}$)	I_D	45	A
Continuous Drain Current ($T_C = 100^{\circ}\text{C}$)	$I_D(100^{\circ}\text{C})$	30	A
Pulsed Drain Current Tested	I_{DM}	180	A
Single Pulse Avalanche Energy ¹⁾	E_{AS}	132	mJ
Power Dissipation ($T_C = 25^{\circ}\text{C}$)	P_D	60	W
Thermal Resistance Junction to Case	$R_{\theta JC}$	2.08	$^{\circ}\text{C/W}$
Operating Junction Temperature	T_J	$-55 \sim +150$	$^{\circ}\text{C}$
Storage Temperature Range	T_{STG}	$-55 \sim +150$	$^{\circ}\text{C}$

Electrical characteristics ($T_A=25^{\circ}\text{C}$, unless otherwise noted)

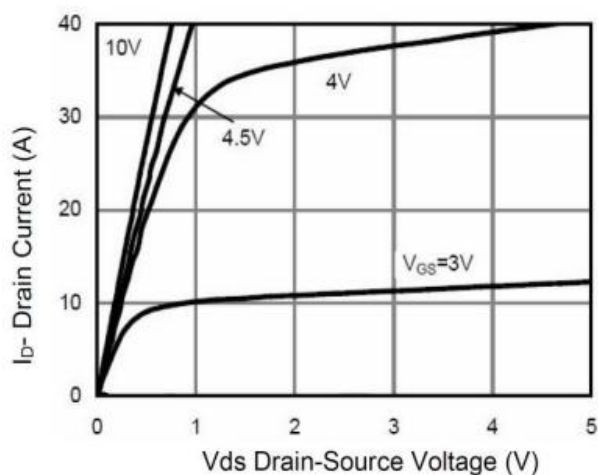
Parameter	Symbol	Test Condition	Min.	Typ.	Max.	Unit
Static Characteristics						
Drain-source breakdown voltage	V _{(BR)DSS}	V _{GS} =0V, I _D =250μA	60			V
Zero gate voltage drain current	I _{DSS}	V _{DS} =48V, V _{GS} =0V, T _J =25°C			1	μA
Gate-body leakage current	I _{GSS}	V _{DS} =0V, V _{GS} =±20V			±100	nA
Gate threshold voltage	V _{GS(th)}	V _{DS} =V _{GS} , I _D =250μA	1	1.8	2.5	V
Drain-source on-resistance	R _{DS(on)}	V _{GS} =10V, I _D =20A		13	17	mΩ
		V _{GS} =4.5V, I _D =20A		17	23	
Dynamic characteristics ²⁾						
Input Capacitance	C _{iss}	V _{DS} =30V, V _{GS} =0V, f =1MHz		2050		pF
Output Capacitance	C _{oss}			158		
Reverse Transfer Capacitance	C _{rss}			120		
Total Gate Charge	Q _g	V _{DS} =30V, V _{GS} =10V, I _D =20A		19		nC
Gate-Source Charge	Q _{gs}			7.1		
Gate-Drain Charge	Q _{gd}			7.6		
Turn-on delay time	t _{d(on)}	V _{DS} =30V, V _{GS} =10V, I _D =30A R _G =3Ω		7.4		nS
Turn-on rise time	t _r			5.1		
Turn-off delay time	t _{d(off)}			28.2		
Turn-off fall time	t _f			5.5		
Source-Drain Diode characteristics						
Diode Forward Current	I _S				45	A
Diode Forward voltage	V _{SD}	V _{GS} =0V, I _S =1A, T _J =25°C			1.2	V
Reverse recover time	T _{rr}	I _S =20A, di/dt =100A/us, T _J =25°C		22		nS
Reverse recovery charge	Q _{rr}			11		nC

Notes:

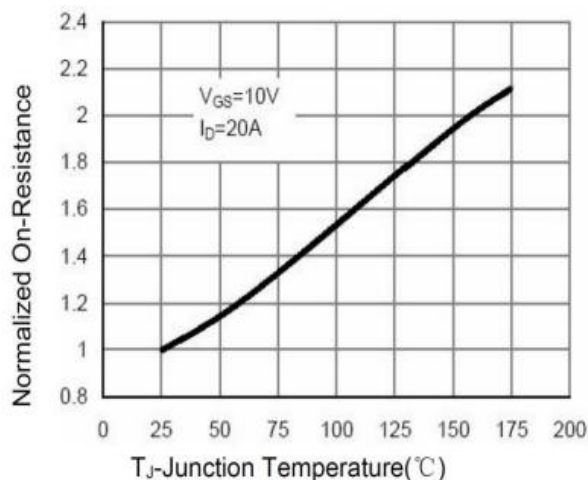
1) EAS condition: $V_{DD} = 30V, V_{GS} = 10V, L = 0.5mH, R_g = 25\Omega$.

2) Guaranteed by design, not subject to production.

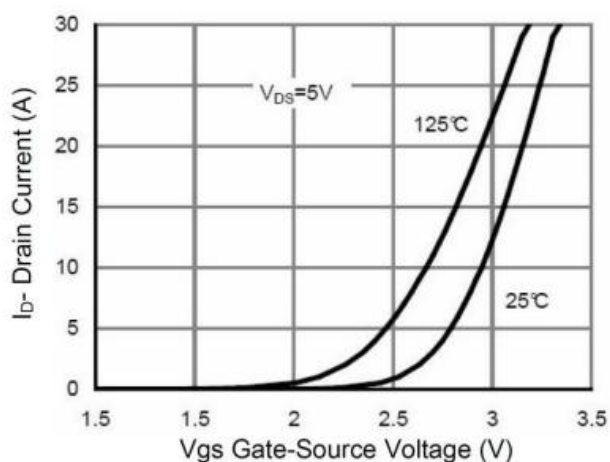
Typical Characteristics



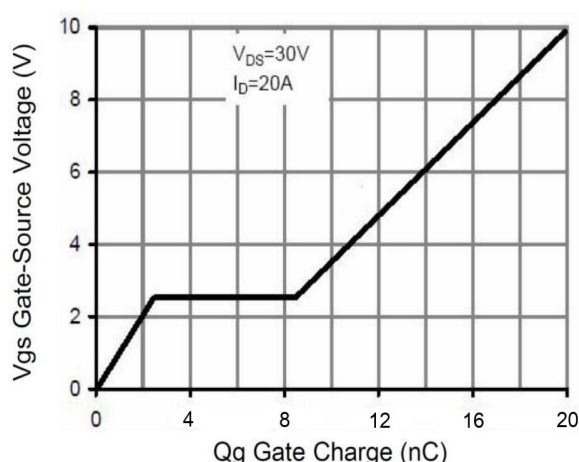
Output Characteristics



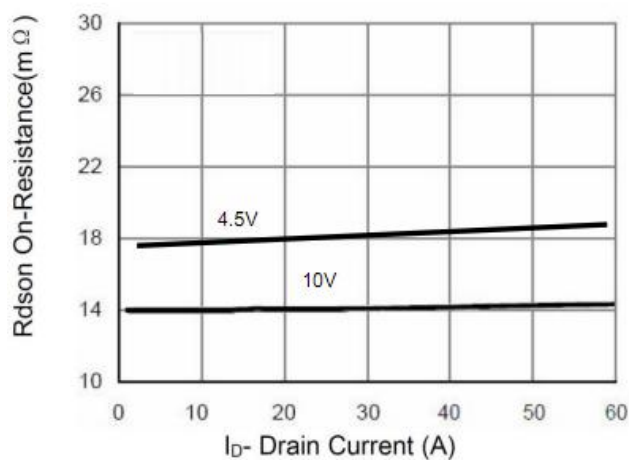
Rdson-Junction Temperature



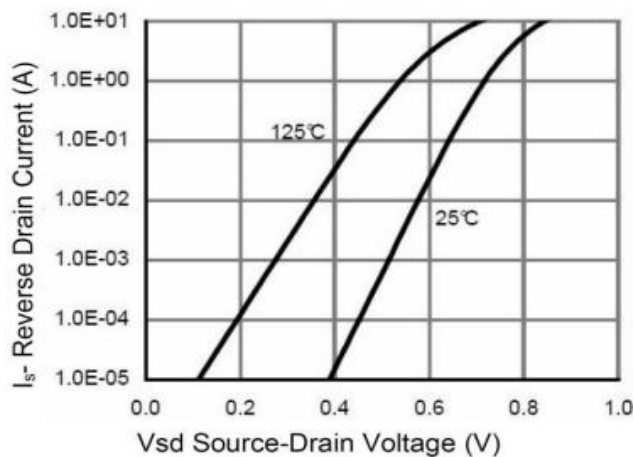
Transfer Characteristics



Gate Charge

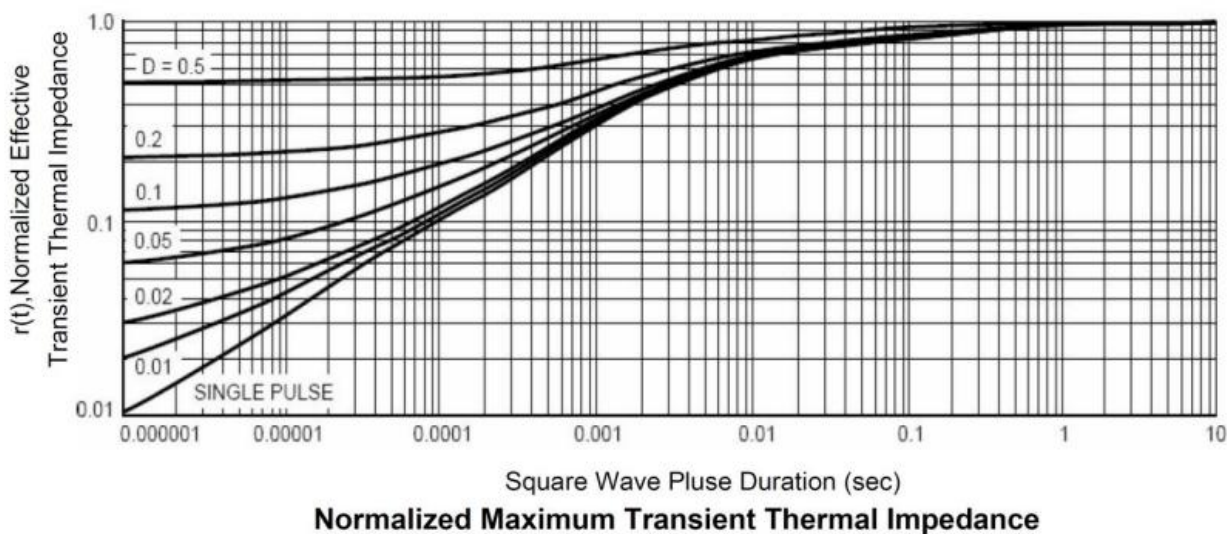
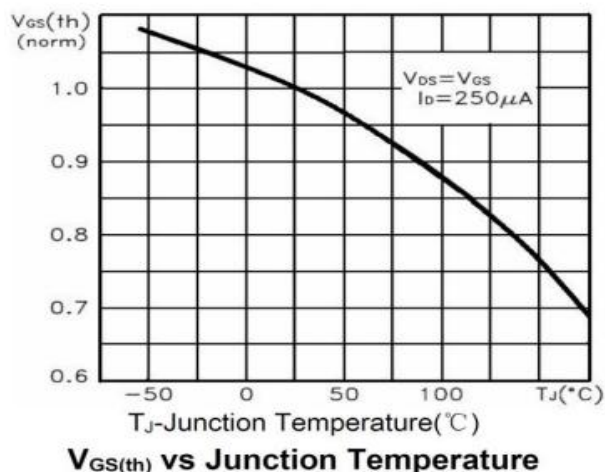
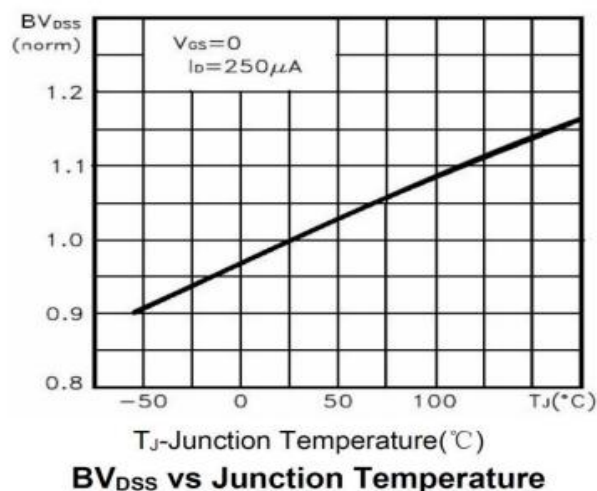
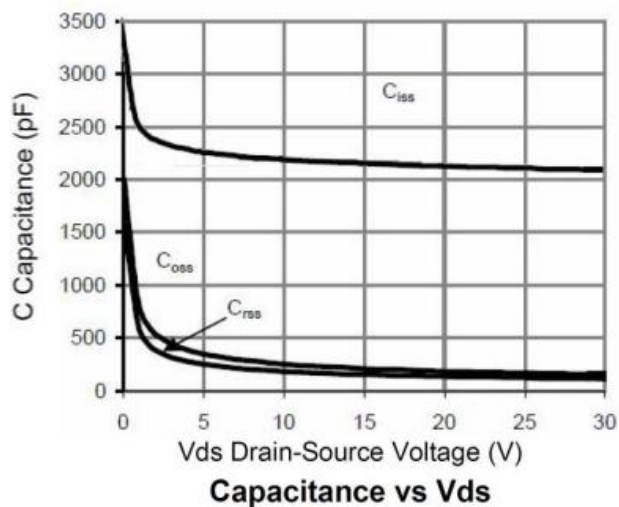


Rdson- Drain Current

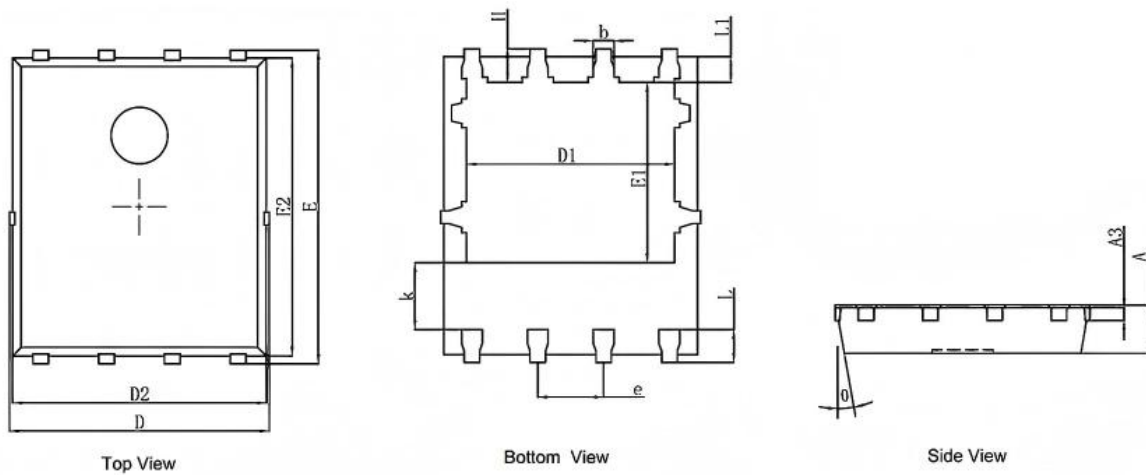


Source- Drain Diode Forward

Typical Characteristics



PDFN5*6-8L Package Information



Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min.	Max.	Min.	Max.
A	0.900	1.000	0.035	0.039
A3	0.245 REF.		0.010 REF.	
D	4.944	5.096	0.195	0.201
E	5.974	6.126	0.235	0.241
D1	3.910	4.110	0.154	0.162
E1	3.375	3.575	0.133	0.141
D2	4.824	4.976	0.190	0.196
E2	5.674	5.826	0.223	0.229
k	1.190	1.390	0.047	0.055
b	0.350	0.450	0.014	0.018
e	1.270 TYP.		0.050 TYP.	
L	0.559	0.711	0.022	0.028
L1	0.424	0.576	0.017	0.023
H	0.574	0.726	0.023	0.029
θ	10°	12°	10°	12°